

Is Now Part of



# **ON Semiconductor**®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any lay bed ON Semiconductor and its officers, employees, ween if such claim alleges that ON Semiconductor was negligent regarding the d



## FAN5350 3MHz, 600mA Step-Down DC-DC Converter in Chip-Scale and MLP Packaging

#### Features

- 3MHz Fixed-Frequency Operation
- 16µA Typical Quiescent Current
- 600mA Output Current Capability
- 2.7V to 5.5V Input Voltage Range
- 1.82V Fixed Output Voltage
- Synchronous Operation
- Power-Save Mode
- Soft-Start Capability
- Input Under-Voltage Lockout (UVLO)
- Thermal Shutdown and Overload Protection
- 6-Lead 3 x 3mm MLP
- 5-Bump 1 x 1.37mm WLCSP

#### Applications

- Cell Phones, Smart-Phones
- Pocket PCs
- WLAN DC-DC Converter Modules
- PDA, DSC, PMP, and MP3 Players
- Portable Hard Disk Drives

#### Description

The FAN5350 is a step-down switching voltage regulator that delivers a fixed 1.82V from an input voltage supply of 2.7V to 5.5V. Using a proprietary architecture with synchronous rectification, the FAN5350 is capable of delivering 600mA at over 90% efficiency, while maintaining a very high efficiency of over 80% at load currents as low as 1mA. The regulator operates at a nominal fixed frequency of 3MHz at full load, which reduces the value of the external components to 1 $\mu$ H for the output inductor and 4.7 $\mu$ F for the output capacitor.

At moderate and light loads, pulse frequency modulation is used to operate the device in power-save mode with a typical quiescent current of  $16\mu$ A. Even with such a low quiescent current, the part exhibits excellent transient response during large load swings. At higher loads, the system automatically switches to fixed-frequency control, operating at 3MHz. In shutdown mode, the supply current drops below  $1\mu$ A, reducing power consumption.

The FAN5350 is available in a 6-lead Molded Leadless Package (MLP) and a 5-bump Wafer Level Chip Scale Package (WLCSP).

#### **Ordering Information**

Part Number	Operating Temperature Range	Package	Eco Status	Packing Method
FAN5350UCX	-40°C to 85°C	5-Ball, Type-1 WL-CSP, 1x1.37mm, .5mm Pitch	Green	Tape and Reel
FAN5350MPX	-40°C to 85°C	6-Lead, Molded Leadless Package (MLP), Dual, JEDEC MO-229, 3mm Square, Extended DAP	Green	Tape and Reel

For Fairchild's definition of Eco Status, please visit: <u>http://www.fairchildsemi.com/company/green/rohs\_green.html</u>. Please refer to tape and reel specifications at <u>www.fairchildsemi.com</u>; <u>http://www.fairchildsemi.com/packaging</u>.

www.fairchildsemi.com





Pin #	Name	Description
A1	V <sub>IN</sub>	Power Supply Input.
A3	GND	Ground Pin. Signal and power ground for the part.
C1	EN	<b>Enable Pin</b> . The device is in shutdown mode when voltage to this pin is <0.4V and enabled when >1.2V. Do not leave this pin floating.
C3	FB	Feedback Analog Input. Connect directly to the output capacitor.
B2	SW	Switching Node. Connection to the internal PFET switch and NFET synchronous rectifier.

#### MLP

Pin #	Name	Description
1	PGND	<b>Power Ground Pin</b> . Power stage ground. Connect PGND and AGND together via the board ground plane.
2	AGND	Analog Ground Pin. Signal ground for the part.
3	FB	Feedback Analog Input. Connect directly to the output capacitor.
4	EN	<b>Enable Pin</b> . The device is in shutdown mode when voltage to this pin is <0.4V and enabled when >1.2V. Do not leave this pin floating.
5	SW	Switching Node. Connection to the internal PFET switch and NFET synchronous rectifier.
6	V <sub>IN</sub>	Power Supply Input.

### Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol			Min.	Max.	Unit	
V	Input Voltage with respect to	GND		-0.3	6.0	V
V <sub>IN</sub>	Voltage on any other pin with	n respect to GND		-0.3	V <sub>IN</sub>	V
TJ	Junction Temperature		-40	+150	°C	
T <sub>STG</sub>	Storage Temperature			-65	+150	°C
TL	Lead Temperature (Soldering 10 Seconds)				+260	°C
		Human Body Model		4.5		
ESD	Electrostatic Discharge	Charged Device Medal	MLP	1.5		kV
E3D	Protection Level	Charged Device Model	WLCSP	2.0		
		Machine Model		200		V

### **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Тур.	Max.	Unit
Vcc	Supply Voltage Range	2.7		5.5	V
I <sub>OUT</sub>	Output Current	0		600	mA
L	Inductor	0.7	1.0	3.0	μH
CIN	Input Capacitor	3.3	4.7	12.0	μF
C <sub>OUT</sub>	Output Capacitor	3.3	4.7	12.0	μF
T <sub>A</sub>	Operating Ambient Temperature	-40		+85	°C
TJ	Operating Junction Temperature	-40	7	+125	°C

### **Thermal Properties**

Symbol	Parameter	Min.	Тур.	Max.	Units
$\Theta_{JA_WLCSP}$	Junction-to-Ambient Thermal Resistance <sup>(1)</sup>		180		°C/W
$\Theta_{JA_{MLP}}$	Junction-to-Ambient Thermal Resistance <sup>(1)</sup>		49		°C/W

Note:

FAN5350 Rev. 1.0.5

1. Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 1s2p boards in accordance to JESD51- JEDEC standard. Special attention must be paid not to exceed junction temperature  $T_{J(max)}$  at a given ambient temperate  $T_A$ .

### **Electrical Characteristics**

Minimum and maximum values are at  $V_{IN}$  = 2.7V to 5.5V,  $T_A$  = -40°C to +85°C,  $C_{IN}$  =  $C_{OUT}$  = 4.7µF, L = 1µH, unless otherwise noted. Typical values are at  $T_A$  = 25°C,  $V_{IN}$  =3.6V.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
Power Su	ipplies		L	L		
	Quiescent Current	Device is not switching, EN=V <sub>IN</sub>		16		μA
Ι <sub>Q</sub>	Quiescent Current	Device is switching, EN=V <sub>IN</sub>		18	25	μA
I <sub>(SD)</sub>	Shutdown Supply Current	V <sub>IN</sub> = 3.6V, EN = GND		0.05	1.00	μA
		Rising Edge	1.8		2.1	v
Vuvlo	Under-Voltage Lockout Threshold	Falling Edge	1.75		1.95	v
$V_{(\text{ENH})}$	Enable HIGH-Level Input Voltage		1.2			V
$V_{(\text{ENL})}$	Enable LOW-Level Input Voltage				0.4	V
I <sub>(EN)</sub>	Enable Input Leakage Current	EN = V <sub>IN</sub> or GND		0.01	1.00	μA
Oscillato	r					
f <sub>0SC</sub>	Oscillator Frequency		2.5	3.0	3.5	MHz
Regulatio	on					
		$I_{LOAD} = 0$ to 600mA	1.775	1.820	1.865	V
Vo	Output Voltage Accuracy	ССМ	1.784	1.820	1.856	V
tss	Soft-Start	EN = 0 -> 1			300	μs
Output D	river					
	PMOS On Resistance	$V_{IN} = V_{GS} = 3.6V$		180		mΩ
R <sub>DS(on)</sub>	NMOS On Resistance	$V_{IN} = V_{GS} = 3.6V$		170		mΩ
I <sub>LIM</sub>	PMOS Peak Current Limit	Open-Loop <sup>(2)</sup>	650	800	900	mA
T <sub>TSD</sub>	Thermal Shutdown	CCM Only		150		°C
T <sub>HYS</sub>	Thermal Shutdown Hysteresis			20		°C

Note:

2. The Electrical Characteristics table reflects open-loop data. Refer to Operation Description and Typical Characteristic for closed-loop data.

### **Operation Description**

The FAN5350 is a step-down switching voltage regulator that delivers a fixed 1.82V from an input voltage supply of 2.7V to 5.5V. Using a proprietary architecture with synchronous rectification, the FAN5350 is capable of delivering 600mA at over 90% efficiency, while maintaining a light load efficiency of over 80% at load currents as low as 1mA. The regulator operates at a nominal frequency of 3MHz at full load, which reduces the value of the external components to 1 $\mu$ H for the output inductor and 4.7 $\mu$ F for the output capacitor.

#### **Control Scheme**

The FAN5350 uses a proprietary non-linear, fixedfrequency PWM modulator to deliver a fast load transient response, while maintaining a constant switching frequency over a wide range of operating conditions. The regulator performance is independent of the output capacitor ESR, allowing for the use of ceramic output capacitors. Although this type of operation normally results in a switching frequency that varies with input voltage and load current, an internal frequency loop holds the switching frequency constant over a large range of input voltages and load currents.

For very light loads, the FAN5350 operates in discontinuous current (DCM) single-pulse PFM mode, which produces low output ripple compared with other PFM architectures. Transition between PWM and PFM is seamless, with a glitch of less than 14mV at  $V_{OUT}$  during the transition between DCM and CCM modes.

Combined with exceptional transient response characteristics, the very low quiescent current of the controller (<16 $\mu$ A) maintains high efficiency, even at very light loads, while preserving fast transient response for applications requiring very tight output regulation.

#### **Enable and Soft Start**

Maintaining the EN pin LOW keeps the FAN5350 in non-switching mode in which all circuits are off and the part draws ~50nA of current. Increasing EN above its threshold voltage activates the part and starts the softstart cycle. During soft start, the current limit is increased in discrete steps so that the inductor current is increased in a controlled manner. This minimizes any large surge currents on the input and prevents any overshoot of the output voltage.

#### **Under-Voltage Lockout**

When EN is high, the under-voltage lock-out keeps the part from operating until the input supply voltage rises high enough to properly operate. This ensures no misbehavior of the regulator during start-up or shutdown.

#### **Current Limiting**

A heavy load or short circuit on the output causes the current in the inductor to increase until a maximum current threshold is reached in the high-side switch. Upon reaching this point, the high-side switch turns off, preventing high currents from causing damage.

The peak current limit shown in Figure 16,  $I_{LIM(PK)}$  is slightly higher than the open-loop tested current limit,  $I_{LIM(OL)}$ , in the Electrical Characteristics table. This is primarily due to the effect of propagation delays of the IC current limit comparator.

#### Thermal Shutdown

When the die temperature increases, due to a high load condition and/or a high ambient temperature, the output switching is disabled until the temperature on the die has fallen sufficiently. The junction temperature at which the thermal shutdown activates is nominally 150°C with a 20°C hysteresis.

#### **Applications Information**

#### Selecting the Inductor

The output inductor must meet both the required inductance and the energy handling capability of the application.

The inductor value affects the average current limit, the PWM-to-PFM transition point, the output voltage ripple, and the efficiency.

The ripple current ( $\Delta I$ ) of the regulator is:

$$\Delta I \approx \frac{V_{OUT}}{V_{IN}} \bullet \left( \frac{V_{IN} - V_{OUT}}{L \bullet F_{SW}} \right)$$
(1)

The maximum average load current,  $I_{MAX(LOAD)}$  is related to the peak current limit,  $I_{LIM(PK)}$  (see figure 17) by the ripple current:

$$I_{MAX(LOAD)} = I_{LIM(PK)} - \frac{\Delta I}{2}$$
(2)

The transition between PFM and PWM operation is determined by the point at which the inductor valley current crosses zero. The regulator DC current when the inductor current crosses zero,  $I_{DCM}$ , is:

$$I_{\text{DCM}} = \frac{\Delta I}{2} \tag{3}$$

The FAN5350 is optimized for operation with L=1 $\mu$ H, but is stable with inductances ranging from 700nH to 3.0 $\mu$ H. The inductor should be rated to maintain at least 80% of its value at I<sub>LIM(PK)</sub>.

Efficiency is affected by the inductor DCR and inductance value. Decreasing the inductor value for a given physical size typically decreases the DCR; but since  $\Delta I$  increases, the RMS current increases, as do the core and skin effect losses.

$$I_{\text{RMS}} = \sqrt{I_{\text{OUT(DC)}}^2 + \frac{\Delta I^2}{12}}$$
(4)

The increased RMS current produces higher losses through the  $R_{\text{DS}(\text{ON})}$  of the IC MOSFETs as well as the inductor ESR.

Increasing the inductor value produces lower RMS currents, but degrades transient response. For a given physical inductor size, increased inductance usually results in an inductor with lower saturation current.

Table 1 shows the effects of inductance higher or lower than the recommended  $1\mu$ H on regulator performance.

#### **Output Capacitor**

Table 2 suggests 0603 capacitors. 0805 capacitors may further improve performance in that the effective capacitance is higher and ESL is lower than 0603. This improves the transient response and output ripple.

Increasing  $C_{OUT}$  has no effect on loop stability and can therefore be increased to reduce output voltage ripple or to improve transient response. Output voltage ripple,  $\Delta V_{OUT}$ , is:

$$\Delta V_{OUT} = \Delta I \bullet \left( \frac{1}{8 \bullet C_{OUT} \bullet F_{SW}} + ESR \right)$$
(5)

#### Input Capacitor

The 4.7 $\mu$ F ceramic input capacitor should be placed as close as possible between the VIN pin and GND to minimize the parasitic inductance. If a long wire is used to bring power to the IC, additional "bulk" capacitance (electrolytic or tantalum) should be placed between C<sub>IN</sub> and the power source lead to reduce ringing that can occur between the inductance of the power source leads and C<sub>IN</sub>.

Table 1. Effects of changes in inductor value (from 1µH recommended value) on regulator performance

Inductor Value	I <sub>MAX(LOAD)</sub> EQ. 2	I <sub>LIM(PK)</sub>	$\Delta V_{OUT} EQ. 5$	Transient Response
Increase	Increase	Decrease	Decrease	Degraded
Decrease	Decrease	Increase	Increase	Improved

### **PCB Layout Guidelines**

For the bill of materials of the FAN5350 evaluation board, see Table 1. There are only three external components: the inductor and the input and output capacitors. For any buck switcher IC, including the FAN5350, it is always important to place a low-ESR input capacitor very close to the IC, as shown in Figure 7. That ensures good input decoupling, which helps reduce the noise appearing at the output terminals and ensures that the control sections of the IC do not behave erratically due to excessive noise. This reduces switching cycle jitter and ensures good overall performance. It is not considered critical to place either the inductor or the output capacitor very close to the IC. There is some flexibility in moving these two components further away from the IC.

Table 2. FAN5350 Evaluation Board Bill of N	laterials (optional p	arts are installed by request only)

Description		Qty.	Ref.	Vendor	Part Number
	1.2μH, 1.8A, 55mΩ			токо	1117AS-1R2M
Inductor	1.3μH, 1.2A, 90mΩ	1	L1	FDK	MIPSA2520D1R0
	1.5μH, 1.3A	Taiyo Yuden	CBC3225T15MR		
Capacitor 4.7 $\mu$ F, ±10	0%, 6.3V, X5R, 0603	2	CIN, COUT	MURATA	GRM39 X5R 475K 6.3
IC DC/DC Regulator	in CSP, 5 bumps	1	U1	Fairchild	FAN5350UCX
Load Resistor (Optic	onal)	1	R <sub>LOAD</sub>	Any	



Figure 7. The FAN5350 Evaluation Board PCB (CSP)

#### Feedback Loop

One key advantage of the non-linear architecture is that there is no traditional feedback loop. The loop response to changes in  $V_{OUT}$  is essentially instantaneous, which explains its extraordinary transient response. The absence of a traditional, high-gain compensated linear loop means that the FAN5350 is inherently stable over a wide range of  $L_{OUT}$  and  $C_{OUT}$ .

 $L_{OUT}$  can be reduced further for a given application, provided it is confirmed that the calculated peak current for the required maximum load current is less than the minimum of the closed-loop current limit. The advantage is that this generally leads to improved transient response, since a small inductance allows for a much faster increase in current to cope with any sudden load demand.

The inductor can be increased to  $2.2\mu$ H; but, for the same reason, the transient response gets slightly degraded. In that case, increasing the output capacitor to  $10\mu$ F helps significantly.

### **Typical Performance Characteristics**

V<sub>IN</sub> = 3.6V, T<sub>A</sub> = 25°C, V<sub>EN</sub> = V<sub>IN</sub>, according to the circuit in Figure 1 or Figure 2, unless otherwise specified.







Figure 9. Load Regulation, Increasing Load



Figure 10. Switch Mode Operating Areas



Figure 11. Switch Mode Over Temperature



Figure 12. DC Current Voltage Output Characteristics





#### Typical Performance Characteristics (Continued)

V<sub>IN</sub> = 3.6V, T<sub>A</sub> = 25°C, V<sub>EN</sub> = V<sub>IN</sub>, according to the circuit in Figure 1 or Figure 2, unless otherwise specified.





Figure 14. Power Efficiency vs. Load Current







Figure 18. Power Supply Rejection Ratio in CCM

Figure 15. Power Efficiency Over Temperature Range



Figure 17. Shutdown Supply Current vs. Battery Voltage















#### Figure 34. 5-Bump Wafer-Level Chip-Scale Package (WLCSP)

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings: <u>http://www.fairchildsemi.com/packaging/</u>.



#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELABILITY, FUNCTION, OR DESIGN, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvettently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors who are full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

Definition	of Terms
Dennuvn	VITCIIIS

Datasheet Identification Product Status		Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Rev. 147

П

AN5350 — 3MHz, 600mA Step-Down DC-DC Converter in Chip-Scale and MLP Packaging

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC